

Optimizing the Ag/Bi ratio for controlled growth of AgBiS₂ thin films via a two-stage process

U. CHALAPATHI¹, KIRAKALA KIRAN KUMAR², ATHIPALLI DIVYA³, RADHALAYAM DHANALAKSHMI⁴, KRITHIKAA MOHANARANGAM⁵, CUDDAPAH DHANANJAYA RAO⁶, SAMBASIVAM SANGARAJU⁷, C. SAFAROV ABDUVAHID SHUKUROVICH⁸, VASUDEVAREDDY MINNAM REDDY^{9,10}, SI-HYUN PARK^{1,*}

¹Department of Electronic Engineering, Yeungnam University, 280 Daehak-Ro, Gyeongsan, Gyeongbuk 38541, South Korea

²Department of General Physics, Termez State University, Termez, 190111, Uzbekistan

³Department of Physics, School of Technology, The Apollo University, Chittoor, A.P., 517127, India

⁴Department of Physics, University of Santiago of Chile (USACH), Santiago, Chile

⁵Symbiosis Institute of Technology, Pune Campus, Symbiosis International (Deemed University), Pune, India

⁶Department of Physics and Astronomy, Navoi State University, Navoi, 210100, Uzbekistan

⁷National Water & Energy Center, United Arab Emirates University, Al Ain, 15551, UA

⁸Department of Physics and Mathematics Termez State University, Termez, 190111, Uzbekistan

⁹Department of Mathematics, Saveetha School of Engineering, Saveetha Institute of Medical and Technical Sciences (SIMATS), Thandalam, Chennai, 602105, India

¹⁰School of Chemical Engineering, Yeungnam University, Gyeongsan-si, 38541, South Korea

This study focuses on synthesizing AgBiS₂ thin films by sulfurizing Bi/Ag metal precursors in a graphite box. At a ratio of 1.26, Ag₂S secondary phase was present, resulting in nonuniform grain growth, a 0.99 eV energy gap, and 640 Ω cm resistivity. Near-stoichiometric ratios (1.07 and 0.90) eliminated secondary phases, yielding phase-pure AgBiS₂ with uniform grains, a 1.02 eV energy gap, and 13.7 Ω cm resistivity. At a 0.79 ratio, increased crystallinity and resistivity (25 Ω cm) were observed. These results highlight the importance of stoichiometry in fabricating high-quality AgBiS₂ films for solar cells.

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1. Introduction

The quest for light harvesters that are both abundant on Earth and non-toxic is paramount for advancing photovoltaic technology. In recent years, considerable attention has been directed towards ternary chalcogenides within the Cu and Ag-based compound families due to their plentiful presence and environmentally friendly characteristics. Among these, silver bismuth sulfide (AgBiS₂), a member of the I-III-VI family, stands out as a promising contender for its applications in photovoltaics, photoelectrochemical systems, thermoelectric, and supercapacitors. This is primarily due to its favorable optoelectronic properties [1–6]. AgBiS₂ boasts a direct optical bandgap of 0.8 eV and a high absorption coefficient (10⁵ cm⁻¹), rendering it well-suited for employment in solar cells. The AgBiS₂-based solar cells demonstrated a power conversion efficiency of 10% [7, 8]. However, the AgBiS₂-based solar cells described in literature were fabricated utilizing AgBiS₂ quantum dots, a process that involved intricate and time-consuming procedures [9–14]. Furthermore, solutions containing AgBiS₂ quantum dots are susceptible to instability and may aggregate over time. Additionally, the presence of defects induced by organic ligands impose limitations on the reproducibility of the devices, necessitating ligand exchange

and surface engineering of the prepared quantum dots. Challenges such as ensuring batch-to-batch stability of the final composition and implementing effective passivation techniques are common in nanoparticle synthesis approaches [1]. Attaining uniformly dispersed particles in a specific solvent to establish stable ink for thin film deposition presents further obstacles.

Numerous investigations have documented the production of AgBiS₂ thin films through various solution methods such as chemical bath deposition (CBD) [15–17], successive ionic layer adsorption and reaction (SILAR) [18, 19], spray pyrolysis [20], and spin coating [21–23]. Rodriguez et al. [15] pioneered the synthesis of photoconductive AgBiS₂ thin films with a direct bandgap of 0.96 eV, achieved by heating Bi₂S₃/Ag₂S layers grown via CBD at 300 °C under a nitrogen atmosphere of 100 mTorr. Subsequently, Nesheva et al. [16] and Yao et al. [17] employed the same CBD method, with Nesheva studying the photoelectrical properties and Yao investigating photodetection capabilities, particularly for X-ray detection. Huang et al. [18] utilized a two-stage SILAR technique to synthesize AgBiS₂ nanocrystalline thin films, subsequently developing liquid-junction semiconductor-sensitized solar cells with modest power conversion efficiency (PCE) of 0.76%. Calva-Yanez et al. [19] similarly utilized the two-stage SILAR method, achieving a

higher PCE of 2.87% in inorganic-organic hybrid solar cells by depositing AgBiS₂ films on TiO₂ coated substrates. Pai et al. [20] deposited AgBiS₂ thin films via spray pyrolysis, leading to planar heterojunction solar cells with a PCE of 1.5%. Gu et al. [21] employed spin coating to synthesize nanocrystalline cubic AgBiS₂ thin films, revealing both indirect and direct bandgaps of 0.87 eV and 1.21 eV, respectively. Oh et al. [22] reported the synthesis of water-resistant AgBiS₂ nanocrystalline thin films via spin coating, achieving notable solar cell efficiency of 5.75%. Lastly, Kelley et al. [23] demonstrated the synthesis of photoconductive AgBiS₂ quantum dot thin films through spin coating AgBiS₂ quantum dot inks.

The availability of AgBiS₂ thin films synthesized via physical vapor deposition (PVD) methods is limited. Gao et al. [24] demonstrated the fabrication of such films through magnetron sputtering, resulting in grain sizes of 1.2 μm and a bandgap of 0.853 eV. Therefore, the utilization of PVD techniques for AgBiS₂ thin film fabrication is crucial due to the controllability of growth conditions and environmentally friendly synthesis. Additionally, PVD-produced films exhibit desirable properties such as adhesion, resistance, and durability, making them suitable for photovoltaic applications. In our recent work, we synthesized AgBiS₂ thin films by sulfurizing thermally evaporated Bi/Ag metal stacks, exploring the impact of sulfurization temperature on film growth [25]. The elemental composition significantly influences ternary compound formation, as observed in CuSbS₂ and AgSbS₂ thin films where deviations from stoichiometric composition led to secondary phase formation [26, 27]. Hence, precise control over composition ratios during growth is imperative for these compounds. Consequently, our study investigates the influence of the Ag/Bi ratio on the physicochemical properties of AgBiS₂ films prepared via a two-stage method. We examine the structural, microstructural, optical, and electrical characteristics of the AgBiS₂ films concerning the Ag/Bi ratio.

2. Experimental details

2.1. Evaporation of the Bi/Ag metal stacks

Deposition of the Bi/Ag metal stack was conducted using a two-source vacuum evaporation unit. Prior to deposition, soda-lime glass substrates were meticulously cleaned chemically and ultrasonically, along with loading Ag and Bi metal slugs into the chamber. Evaporation utilized foil trough tungsten (W), maintaining a constant boat-to-substrate distance of 36 cm. The chamber's base pressure was sustained at 2×10^{-6} Torr. Thickness estimates for Bi and Ag, crucial for forming a 1 μm AgBiS₂ film via solid-state reaction in an S atmosphere, were deduced from mass density calculations as 400 nm and 190 nm, respectively. Consequently, Bi thickness varied from 380 to 440 nm in 20 nm increments while maintaining Ag thickness at 190 nm. This allowed exploration of the Ag/Bi ratio's impact on AgBiS₂ film growth. Evaporation rates for Bi and Ag were held

constant at 4 $\text{\AA}/\text{s}$ using a quartz crystal thickness monitor. All depositions were conducted at room temperature.

2.2. Transformation of Bi/Ag stacks into AgBiS₂

The evaporated Bi/Ag precursors were subjected to chalcogenization at 400°C for 30 min to transform them into AgBiS₂. The sulfurization temperature and duration were selected based on our previous study [25], which identified 400°C and 30 min as the optimal conditions for preparing high-quality AgBiS₂ thin films. Elemental S was used as the sulfur source. The quartz tube was pressurized with nitrogen up to atmospheric pressure to elevate sulfur pressure and mitigate material re-evaporation. The temperature of the furnace was ramped up at a rate of 10°C/min and the sulfurization ensued for 30 minutes at 400°C, followed by cooling to 250°C at a rate of 2°C/min, and subsequently allowed to cool naturally.

2.3. Characterizations

A PANalytical XRD, utilizing a Cu K α source (0.15406 nm), operated in grazing incidence mode ($\omega = 3^\circ$), was employed to ascertain the crystal structure and phase-purity of the samples. Surface morphologies of the films were documented using a Hitachi S-4800 FESEM, while elemental composition was determined via EDS analysis. Spectral transmittance in the range of 300–2500 nm was recorded using a Cary 5000 UV-Vis-NIR double-beam spectrophotometer. Lastly, electrical properties of the films were determined using an ECOPIA Hall measurement system (HMS-3000, VER 3.53).

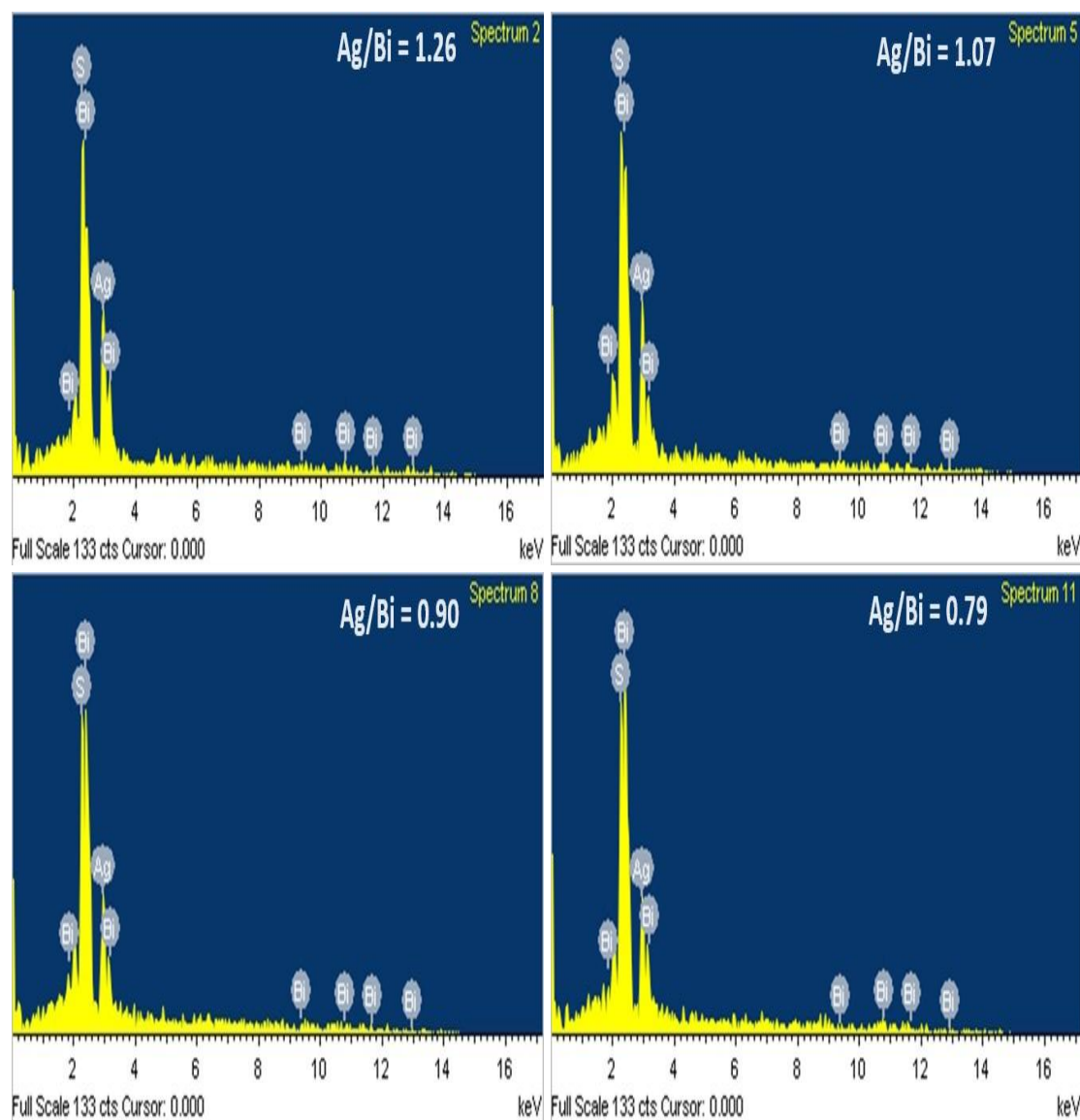
3. Results and discussion

3.1. Compositional analysis

Table 1 presents composition data for AgBiS₂ films with varying Bi thicknesses, revealing systematic shifts in Ag and Bi concentrations as the Bi layer thickness increases. The elemental composition of AgBiS₂ consists of 25% Ag, 25% Bi, and 50% S. For example, the film crafted with a Bi layer thickness of 380 nm exhibited an Ag-rich, Bi-poor composition, with Ag/Bi and S/(Ag+Bi) ratios of 1.26 and 1.0, respectively. Increasing the Bi thickness from 400 nm to 420 nm resulted in higher Bi content and lower Ag content, with the Ag/Bi ratio varying from 1.07 to 0.90. Further increasing the Bi thickness to 440 nm reduced the Ag/Bi ratio to 0.79 without altering the S/(Ag+Bi) ratio. Consequently, increasing the Bi layer thickness decreased the Ag/Bi ratio from 1.26 to 0.79. Fig. 1 displays the EDS spectra of AgBiS₂ films fabricated by varying the Ag/Bi ratio from 1.26 to 0.79, revealing peaks corresponding to Ag, Bi, and S under all conditions. It is evident that increasing the composition ratio enhances the Ag peak intensity while decreasing the Bi intensity, consistent with the atomic percentages outlined in Table 1.

Table 1. EDS data of AgBiS₂ films produced from the Bi/Ag stacks with different thicknesses

Bi/Ag stack thickness (nm)	Atomic percentage			Ratio	
	Ag	Bi	S	Ag/Bi	S/(Ag+Bi)
380/190	27.8	22.1	50.1	1.26	1.00
400/190	26.4	24.7	48.9	1.07	0.96
420/190	25.1	27.5	47.4	0.90	0.90
440/190	23.2	29.5	47.3	0.79	0.90

Fig. 1. EDS spectra of the AgBiS₂ films produced from Bi/Ag stacks with varying thicknesses of Bi (colour online)

3.2. Structural analysis

Fig. 2 illustrates the XRD patterns of AgBiS₂ films fabricated with various Ag/Bi ratios. When the Ag/Bi ratio is 1.26, the film exhibits predominant diffraction peaks at 27.28°, 31.54°, 45.27°, 53.66°, and 56.30°, matching the standard diffraction pattern of AgBiS₂ (JCPDS Card No. 01-089-2045). Additionally, weak peaks at 34.40°, 36.88°,

and 37.72° correspond to monoclinic Ag₂S (JCPDS Card No. 014-0072). The dominant peaks of AgBiS₂ indicate formation of this phase in cubic crystal structure with (111) preferred orientation and lattice parameter of 0.566 nm. Reducing the Ag/Bi ratio to 0.90 eliminates the diffraction peaks of Ag₂S, indicating phase-pure AgBiS₂. Further reduction to 0.79 does not significantly affect peak positions/intensities, with only cubic AgBiS₂ peaks present. Secondary phases like Bi₂S₃ do not appear at this

composition, underscoring the importance of near-stoichiometric composition for phase-pure film growth. A slight shift in the intense (111) peak and a reduction in FWHM suggest variations in lattice parameter and crystallite size, ranging from 0.5664 to 0.5660 nm and from 18.4 to 23 nm, respectively, as the composition shifts from 1.26 to 0.79 [28].

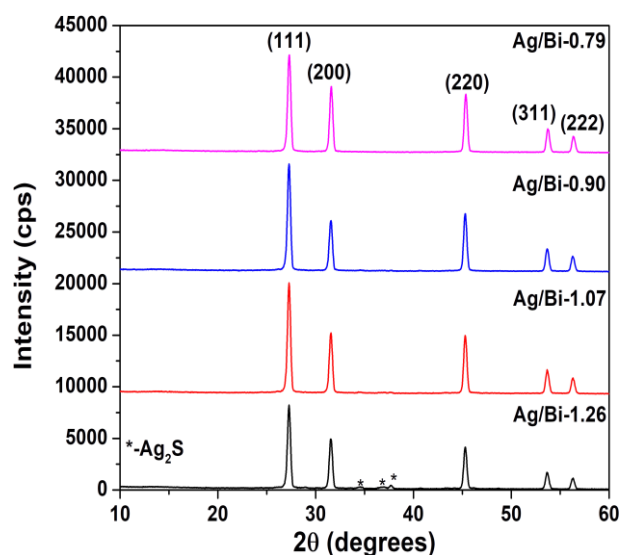


Fig. 2. XRD patterns of AgBiS₂ films fabricated with different Ag/Bi ratios (colour online)

The phase purity of the samples was further examined using Raman spectroscopy, as presented in Fig. 3.

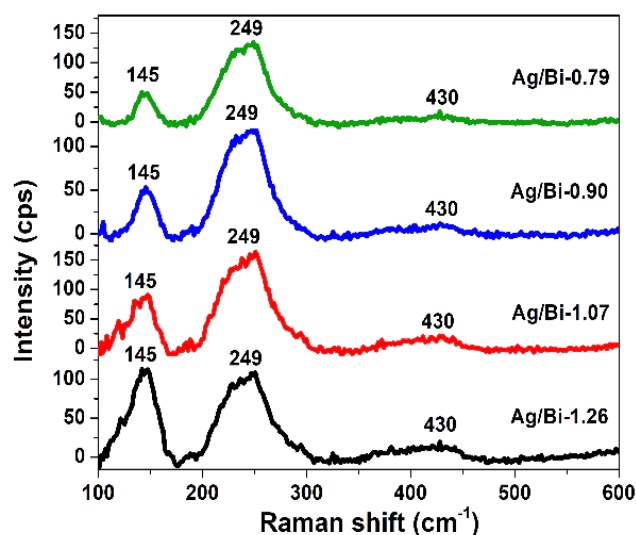


Fig. 3. Raman spectra of AgBiS₂ films fabricated with different Ag/Bi ratios (colour online)

The AgBiS₂ films synthesized with varying Ag/Bi ratios displayed Raman features at 145 cm⁻¹, 249 cm⁻¹, and 430 cm⁻¹. Notably, the intensity of the 145 cm⁻¹ mode decreased, whereas the 249 cm⁻¹ mode became more prominent as the Ag/Bi ratio was reduced from 1.26 to 0.79, reflecting changes in the local chemical environment. These observed modes are consistent with the reported Raman bands of AgBiS₂ at 147 cm⁻¹, 237–248 cm⁻¹, and 436 cm⁻¹ [29, 30]. Furthermore, the absence of Raman signatures corresponding to Bi₂S₃ [31] and Ag₂S [32] suggests that these secondary phases are either not present or lie below the probing depth of the Raman measurement.

3.3. Morphological analysis

Fig. 4 displays the microstructure of AgBiS₂ films fabricated with varying Ag/Bi ratios. The micrographs illustrate that the grain growth of AgBiS₂ is notably influenced by these ratios. For instance, the AgBiS₂ film fabricated with the composition ratio of 1.26 reveals distinct nonuniform grains measuring 1.0–2.0 μm in size, along with crater-like regions on the surfaces. This nonuniform grain growth is likely due to the Ag₂S and AgBiS₂ phases, as confirmed by XRD analysis. Conversely, when the composition ratio varied from 1.07 to 0.90, a significant improvement in compactness, grain size, and uniformity, with an average grain size of 2.0–2.5 μm were observed. This enhancement in grain growth and morphology correlates with an increasing Ag/Bi ratio, suggesting improved phase purity of the films as observed from XRD analysis. Further reduction of the Ag/Bi ratio to 0.79 results in decreased grain size (1.0–2.0 μm) and the formation of crater-like regions on the surface, indicating a loss of material with higher Bi concentration. These observations underscore the importance of a near-stoichiometric composition for achieving compact and large-grained AgBiS₂ thin films.

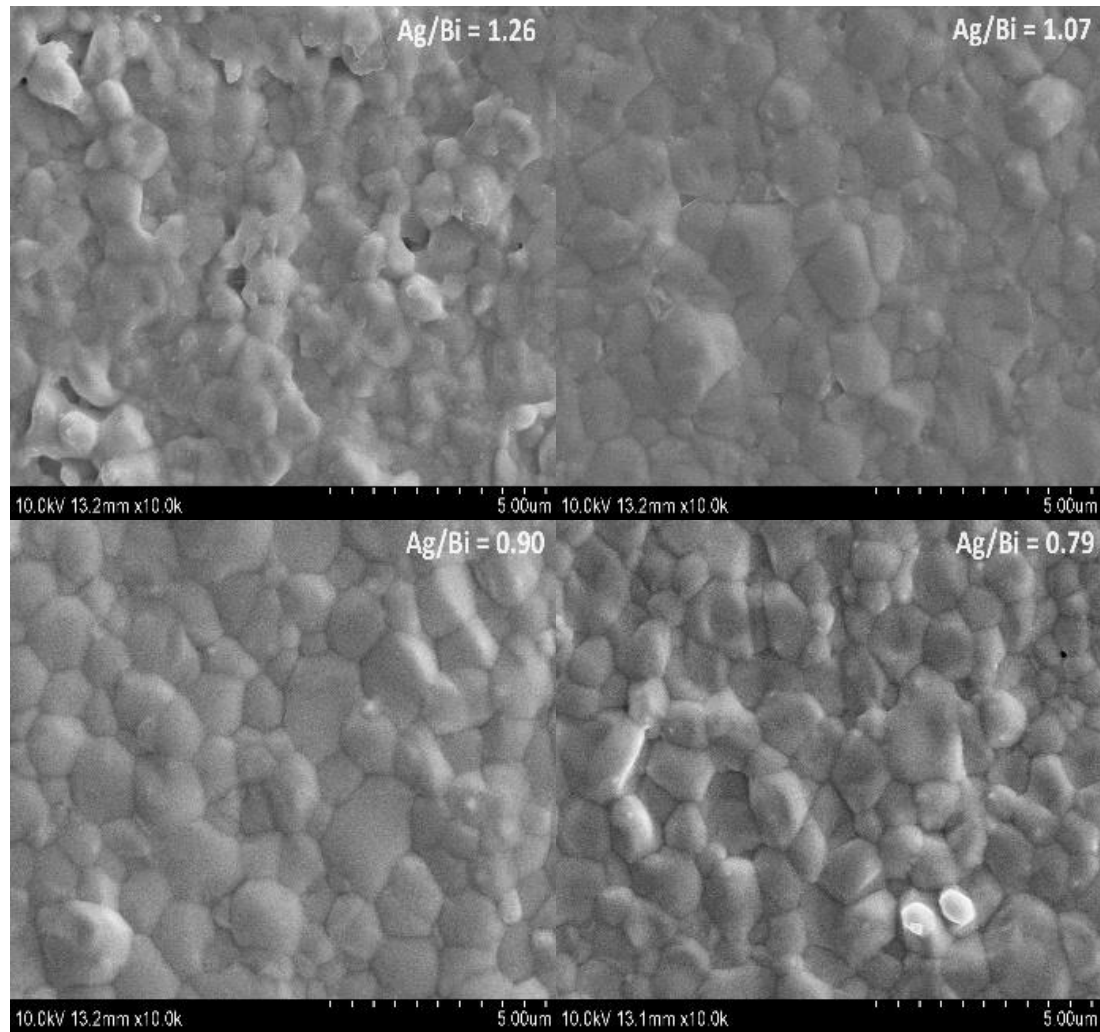


Fig. 4. FESEM micrographs of the AgBiS_2 films fabricated with different Ag/Bi ratios

Fig. 5 depicts cross-sectional FESEM images of the films, illustrating the vertical grain growth as the Ag/Bi ratios vary. Notably, the composition ratios exert a significant influence on both film thickness and grain size throughout the thickness. For instance, at a composition ratio of 1.26, a compact and firmly adherent layer form with columnar grain growth up to 800 nm in thickness.

Conversely, reducing the composition ratio from 1.07 to 0.90 results in increased grain size, reaching 1000 nm throughout the thickness. Further reduction to a composition ratio of 0.79 increases film thickness to 1200 nm, characterized by columnar grains covered by a smear top surface.

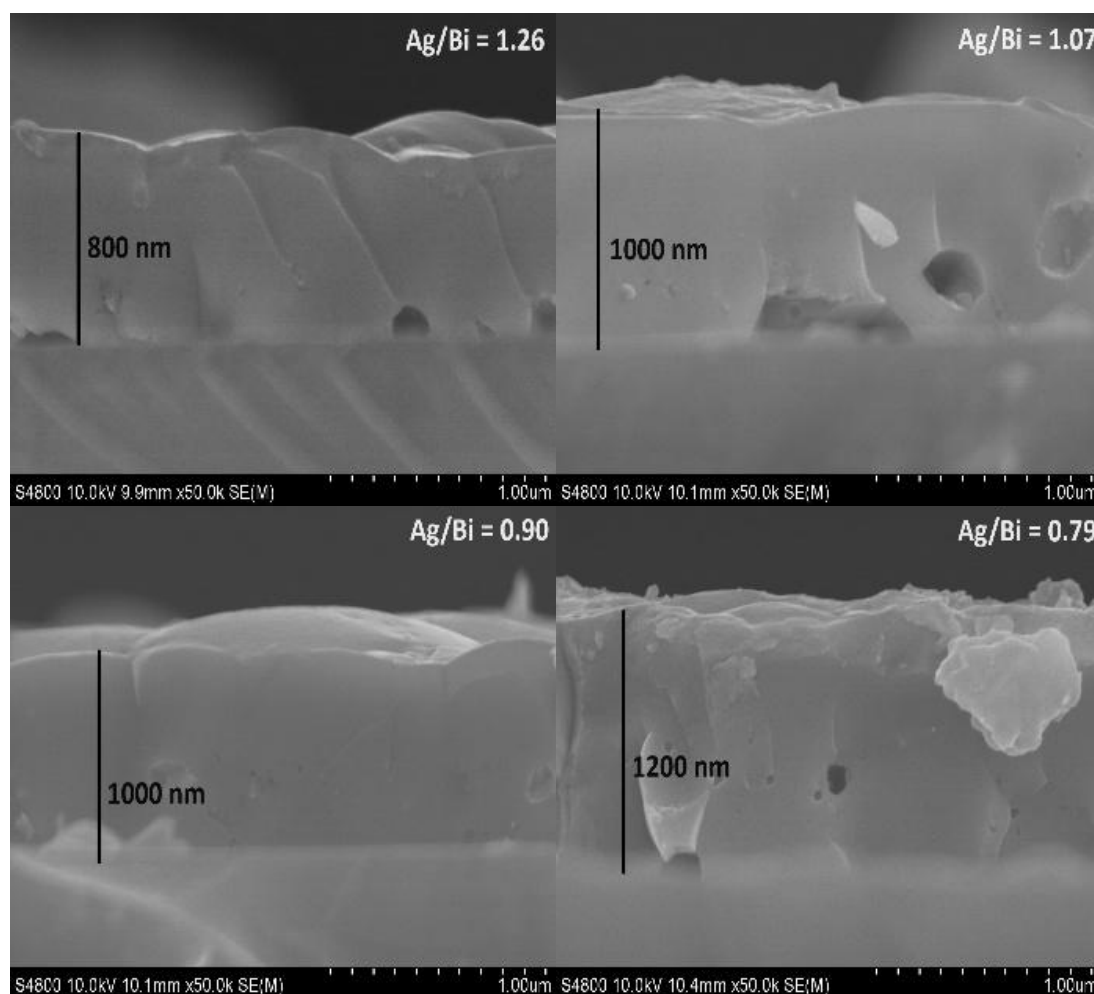


Fig. 5. Cross-sectional FESEM images of the AgBiS₂ films fabricated with different Ag/Bi ratios

3.4. Optical absorption

The optical properties of the AgBiS₂ films were determined using the transmittance data depicted in Figure 6. It's notable that varying the Ag/Bi ratio did not significantly alter the transmittance of the films. For instance, the film with the composition ratio of 1.26 exhibited a low optical transmittance (15%) at longer wavelengths and displayed an onset of absorption ranging from 1480 to 1130 nm. This onset of absorption aligns with the reported onset of absorption for AgBiS₂ [15, 24]. However, the transition corresponding to Ag₂S, a secondary phase in this film, was not discernible due to the strong absorption of the AgBiS₂ phase. Decreasing the composition ratio from 1.07 to 0.90 leads to a slight increase in transmittance to 18%, attributed to enhanced crystallinity and grain size observed from XRD and FESEM analyses. Further reduction in the Ag/Bi ratio to 0.79 marginally decreased transmittance to 15% due to the formation of crater-like regions on the film surface, as observed in FESEM images.

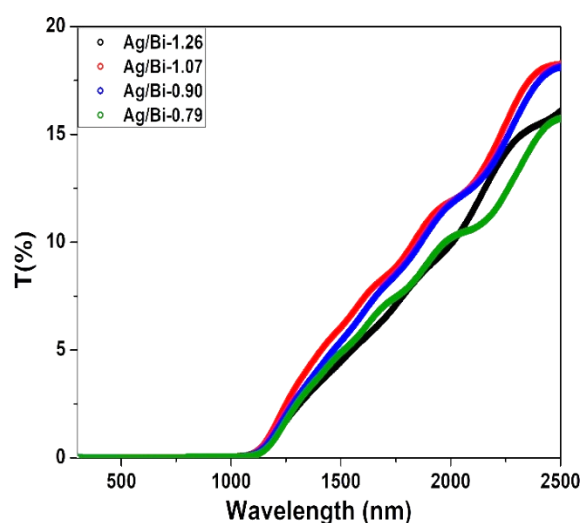


Fig. 6. Spectral transmittance curves of AgBiS₂ films fabricated with different Ag/Bi ratios (colour online)

Fig. 7 presents the $(\alpha h\nu)^2$ versus $h\nu$ curves of AgBiS₂ films fabricated with varying Ag/Bi ratios to ascertain their bandgap energies. The optical absorption coefficient was estimated using $\alpha_\lambda = \ln(1/T_\lambda)/t$, where t represents the film thickness [16, 33, 34]. The energy gap of the AgBiS₂ film

with the composition ratio of 1.26 was determined to be 0.99 eV, with an uncertainty of ± 0.02 eV. Reducing the Ag/Bi ratio from 1.07 to 0.90 slightly increased the energy gap from 0.99 to 1.02 eV, while a further decrease to 0.79 led to a slight decrease in the energy gap to 0.99 eV. These energy gap values are close to the reported values of AgBiS₂ [15, 16]. The slightly lower energy gaps observed for AgBiS₂ films with the composition ratios of 1.26 and 0.79 are due to Ag-rich and Ag-poor compositions, respectively.

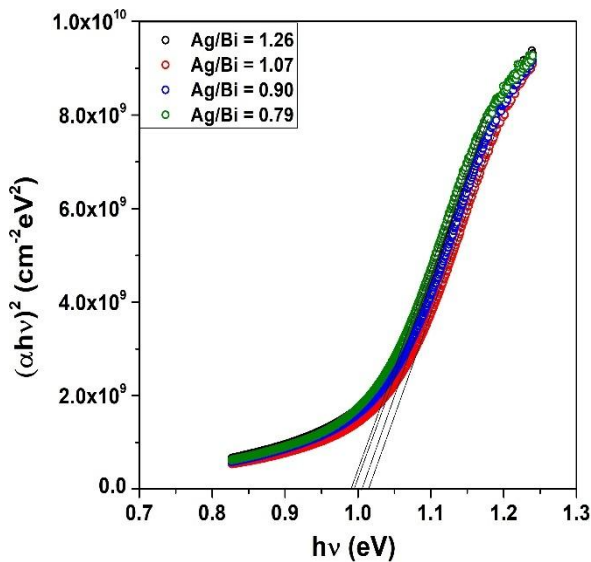


Fig. 7. $(\alpha hv)^2$ vs. $h\nu$ curves of AgBiS₂ films fabricated with different Ag/Bi ratios (colour online)

3.5. Electrical properties

Table 2 illustrates the electrical characteristics of AgBiS₂ films produced with varying Ag/Bi ratios. A negative Hall coefficient was observed in the film

synthesized with the composition ratio of 1.26, indicative of its n-type behavior attributed to the presence of Ag₂S secondary phase. Conversely, films created with decreasing Ag/Bi ratios from 1.07 to 0.79 displayed a positive Hall coefficient, reflecting their p-type conductivity. In Table 2, the electrical resistivity of the film fabricated with an Ag/Bi ratio of 1.26 measured 640 Ω cm, whereas it decreased to 2.5 Ω cm at 1.07 and increased from 13.7 to 25 Ω cm with further reduction of the Ag/Bi ratio to 0.79. Rodriguez et al. [35] reported an electrical resistivity of 1.92×10^4 Ω cm for the AgBiS₂ films prepared by CBD method. The obtained resistivity values are lower than the reported values. The higher resistivity in the Ag-rich (Ag/Bi = 1.26) film was attributed to its mixed-phase nature, while the increase in resistivity with decreasing Ag/Bi ratio from 1.07 to 0.79 may be attributed to higher Bi content. The hole mobility of the film fabricated with the composition ratio of 1.26 was $0.32 \text{ cm}^2 \text{V}^{-1} \text{s}^{-1}$, while it increased from 9.7 to $21.0 \text{ cm}^2 \text{V}^{-1} \text{s}^{-1}$ with a decrease to 0.90 and then reached $9.5 \text{ cm}^2 \text{V}^{-1} \text{s}^{-1}$ at an Ag/Bi ratio of 0.79. Lower mobilities in both the Ag-rich (1.26) and Ag-poor (0.79) films were attributed to smaller grain sizes, while the higher hole mobility in near-stoichiometric films (1.07 and 0.90) was a result of compact, large-grained, and phase-pure films. Regarding carrier concentrations, the Ag-rich (1.26) film exhibited a concentration of $-6.2 \times 10^{16} \text{ cm}^{-3}$, whereas near-stoichiometric films (1.07 and 0.90) ranged from $(2.50\text{--}2.2) \times 10^{17} \text{ cm}^{-3}$, and the Ag-poor film (0.79) showed a decreased concentration of $1.5 \times 10^{17} \text{ cm}^{-3}$. Yasaman [36] reported a hole mobility of $2.88 \text{ cm}^2 \text{V}^{-1} \text{s}^{-1}$ and carrier concentration of $3.2 \times 10^{14} \text{ cm}^{-3}$ for the AgBiS₂ films prepared from the precursor method followed by spin coating. In comparison, the AgBiS₂ films prepared in this study with Ag/Bi ratios of 1.07–0.79 exhibit higher hole mobilities and carrier concentrations, indicating the superior quality of the films.

Table 2. Electrical properties of AgBiS₂ films fabricated with different Ag/Bi ratios

Ag/Bi ratio	Resistivity (Ω cm)	Mobility ($\text{cm}^2 \text{V}^{-1} \text{s}^{-1}$)	Carrier conc. (cm^{-3})
1.26	640	0.32	-6.2×10^{16}
1.07	2.5	9.70	2.5×10^{17}
0.90	13.7	21.0	2.2×10^{17}
0.79	25	9.5	1.2×10^{17}

4. Conclusions

The process involved in fabricating AgBiS₂ thin films entailed sulfurizing Bi/Ag metal precursors deposited via thermal evaporation. The Bi layer thickness ranged from 380 to 440 nm, while the Ag layer remained fixed at 190 nm to investigate the impact of the Ag/Sb ratio on film growth and properties. Films fabricated with a composition ratio of 1.26 exhibited a secondary Ag₂S phase alongside the dominant cubic AgBiS₂ phase. Reducing the composition ratio from

1.07 to 0.79 led to the elimination of the Ag₂S phase, resulting in phase-pure AgBiS₂ films. Moreover, decreasing the composition ratio from 1.26 to 0.79 increased crystallite size from 18.4 to 23 nm. Improvements in compactness, uniformity, and grain size were observed in films with reduced Ag/Bi ratios, specifically from 1.26 to 0.90, although a further decrease to 0.79 diminished these characteristics. The energy gap of AgBiS₂ films ranged from 0.99 to 1.02 eV as the composition ratio varied from 1.26 to 0.79. Near-stoichiometric AgBiS₂ films (ratios of

1.07 and 0.90) displayed slightly lower electrical resistivity, higher hole mobilities, and carrier concentrations compared to Ag-rich (1.26) and Ag-poor (0.79) films. This study underscores the necessity of a near-stoichiometric composition for producing phase-pure, large-grained AgBiS₂ films possessing favorable optical and electrical properties conducive to solar cell applications.

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*Corresponding author: sihyun_park@ynu.ac.kr